SiHP25N50E

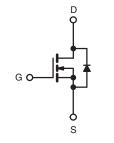
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.145		
Q _g (Max.) (nC)	86			
Q _{gs} (nC)	14			
Q _{gd} (nC)	25			
Configuration	Single			





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM): Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATONS

- · Hard switched topologies
- Power factor correction power supplies (PFC)
- Switch mode power supplies (SMPS)
- Computing
 - PC silver box / ATX power supplies
- Lighting
- Two stage LED lighting

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free and Halogen-free	SiHP25N50E-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	500	V
Gate-Source Voltage			V _{GS}	± 30	- v
Continuous Drain Current (T _{.I} = 150 °C)	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1	26	
Continuous Drain Current (1j = 150°C)	V _{GS} at 10 V	T _C = 100 °C	I _D	16	А
Pulsed Drain Current ^a			I _{DM}	50	
Linear Derating Factor				0.2	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	273	mJ
Maximum Power Dissipation			PD	250	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope $V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		dV/dt	65	1//20	
Reverse Diode dV/dt ^d			25	V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_q = 25 \Omega$, $I_{AS} = 4.4$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.5	0/10	

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		•	•	•	•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.59	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Cata Source Leakage	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage			V _{GS} = ± 30 V	-	-	± 1	μA
Zara Cata Valtaga Drain Currant		V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	25	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 12 A	-	0.125	0.145	Ω
Forward Transconductance	g fs	V _{DS}	= 30 V, I _D = 12 A	-	6.6	-	S
Dynamic					•	•	
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	1980	-	-
Output Capacitance	C _{oss}		V _{DS} = 100 V,	-	105	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	8	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	- V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	105	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	285	-]
Total Gate Charge	Qg				57	86	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V I _D = 12 A, V _{DS} = 400 V		-	14	-	
Gate-Drain Charge	Q _{gd}				25	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 400 V, I _D = 12 A R _g = 9.1 Ω, V _{GS} = 10 V		-	19	38	
Rise Time	t _r			-	36	72	ns
Turn-Off Delay Time	t _{d(off)}			-	57	86	
Fall Time	t _f			-	29	58	1
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.56	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12	
Pulsed Diode Forward Current	I _{SM}			-	-	50	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 16.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	338	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S,$ dl/dt = 100 A/µs, V _R = 25 V		-	5.3	-	μC
Reverse Recovery Current	I _{RRM}			-	29	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

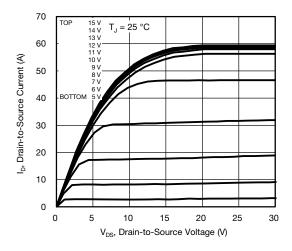
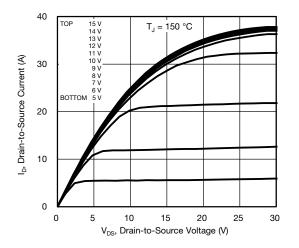


Fig. 1 - Typical Output Characteristics





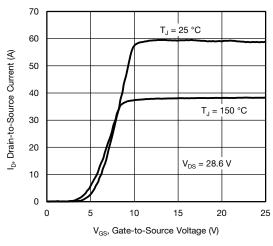


Fig. 3 - Typical Transfer Characteristics

3.0 12 R_{DS(on)}, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.0 0.5 0 -40 -60 -20 0 20 40 60 80 100 120 140 160 T_., Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

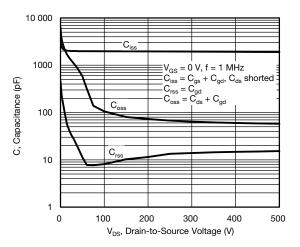


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

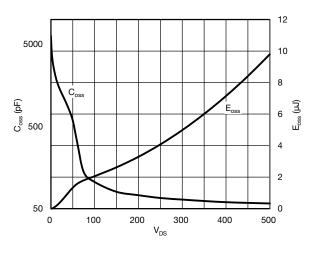


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

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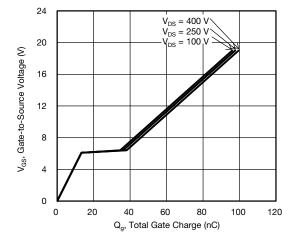


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

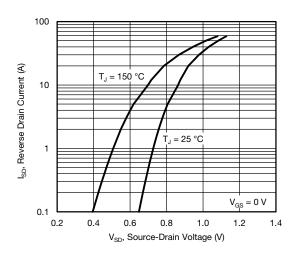


Fig. 8 - Typical Source-Drain Diode Forward Voltage

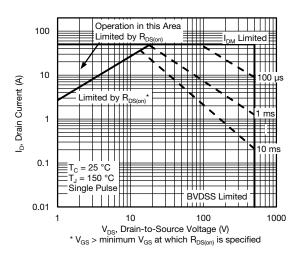


Fig. 9 - Maximum Safe Operating Area

30 24 (*) La 18 12 6 0

Fig. 10 - Maximum Drain Current vs. Case Temperature

T_C, Case Temperature (°C)

75

100

125

150

25

50

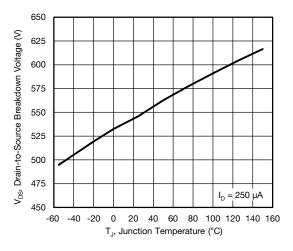


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

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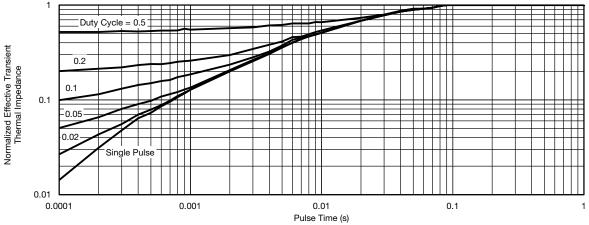


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

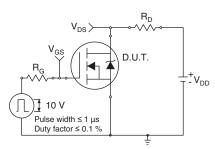


Fig. 13 - Switching Time Test Circuit

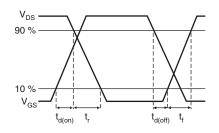


Fig. 14 - Switching Time Waveforms

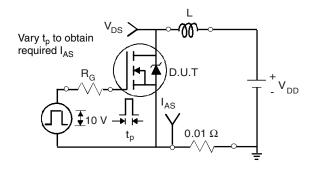


Fig. 15 - Unclamped Inductive Test Circuit

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edance, Junction-to-Case

Fig. 16 - Unclamped Inductive Waveforms

 I_{AS}

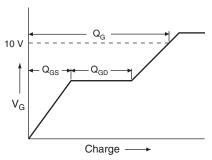
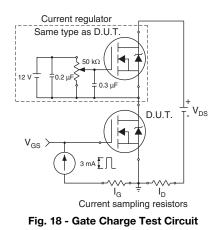
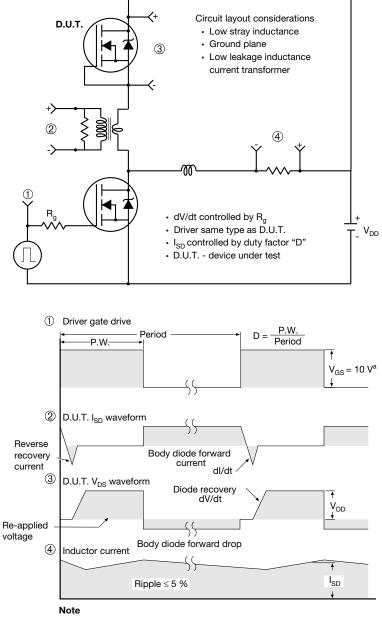


Fig. 17 - Basic Gate Charge Waveform





Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi	'an		
		IRF 9510 744K AB			

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